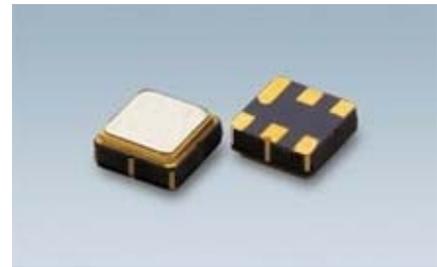


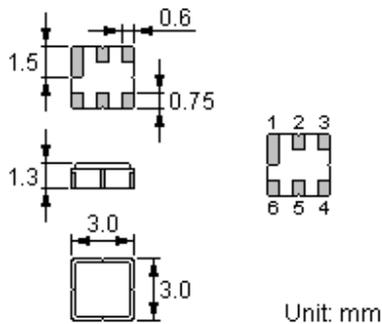
**Features**

- Low-loss RF filter for mobile systems
- Low amplitude ripple
- No matching network required for operation at 50Ω
- Ceramic package for **Surface Mounted Technology (SMT)**
- Lead-free production and **RoHS** compliant



**Package Dimensions**

Ceramic Package: **DCC6C**



**Pin Configuration**

2	Input
5	Output
1, 3, 4, 6	Ground

**Marking**



Top View, Laser Marking

- "ND": Manufacturer's mark
- "F": SAW filter
- "NDF9163": Part number
- " . ": Terminal 1
- " \* ": Lot number (The code shown below varies in a 4-year cycle)

Code	1	2	3	4	5	6	7	8	9	10	11	12
2009	A	B	C	D	E	F	G	H	J	K	L	M
2010	N	P	Q	R	S	T	U	V	W	X	Y	Z
2011	a	b	c	d	e	f	g	h	i	j	k	m
2012	n	p	q	r	s	t	u	v	w	x	y	z

**Maximum Ratings**

Rating	Value	Unit
Input Power Level	$P$	10 dBm
DC Voltage	$V_{DC}$	0 V
Operating Temperature Range	$T_A$	-40 ~ +85 °C
Storage Temperature Range	$T_{stg}$	-40 ~ +85 °C

**Electrical Characteristics**

Characteristic		Min.	Typ.	Max.	Unit
Center Frequency	$f_c$	--	1745	--	MHz
Insertion Loss	$IL$ 1735 MHz .... 1755 MHz	--	3.0	4.0	dB
Usable Bandwidth	$BW$	--	20	--	MHz
Pass Band Ripple	$\Delta\alpha$ 1735 MHz .... 1755MHz	--	1.0	1.5	dB
Absolute Attenuation	$\alpha$				
	DC---1545MHz	38	42		dB
	1545---1675MHz	30	35		dB
	1675---1715MHz	4	5		dB
	1775---1805MHz	4	5	--	dB
	1805---1880MHz	40	45	--	dB
	1880---2025MHz	36	40		dB
	2025---3000MHz	30	35		dB
Group Delay Ripple	1735 MHz .... 1755MHz		15	40	ns
Input VSWR / Output VSWR			1.9:1	2.2:1	

**RoHS Compliant**

**Electrostatic Sensitive Device**

**Typical Frequency Response**



**Stability Characteristics**

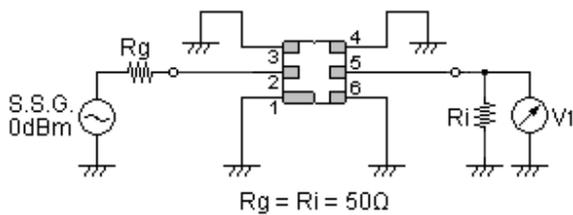
	Test item	Condition of test
1	Mechanical shock	(a) Drops: 3 times on concrete floor (b) Height: 1.0 m
2	Vibration resistance	(a) Frequency of vibration: 10~55Hz (c) Directions: X,Y and Z (b) Amplitude: 1.5 mm (d) Duration: 2 hours
3	Moisture resistance	(a) Condition: 40°C, 90~95% R.H. (c) Wait 4 hours before measurement (b) Duration: 96 hours
4	Climatic sequence	(a) +70°C for 16 hours (c) -25°C for 2 hours (e) Wait 4 hours before measurement (b) +55°C for 24 hours, 90~95% R.H. (d) +40°C for 24 hours, 90~95% R.H.
5	High temperature exposure	(a) Temperature: 70°C (c) Wait 4 hours before measurement (b) Duration: 250 hours
6	Thermal impact	(a) +70°C for 30 minutes ⇒ -25°C for 30 minutes repeated 3 times (b) Wait 4 hours before measurement

**Requirements:** The SAW filter shall remain within the electrical specifications after tests.

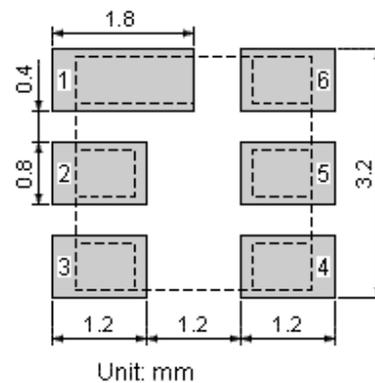
**Remarks**

- SAW devices should not be used in any type of fluid such as water, oil, organic solvent, etc.
- Be certain not to apply voltage exceeding the rated voltage of components.
- Do not operate outside the recommended operating temperature range of components.
- Sudden change of temperature shall be avoided, deterioration of the characteristics can occur.
- Be careful of soldering temperature and duration of components when soldering.
- Do not place soldering iron on the body of components.
- Be careful not to subject the terminals or leads of components to excessive force.
- SAW devices are electrostatic sensitive. Please avoid static voltage during operation and storage.
- Ultrasonic cleaning shall be avoided. Ultrasonic vibration may cause destruction of components.

**Test Circuit**

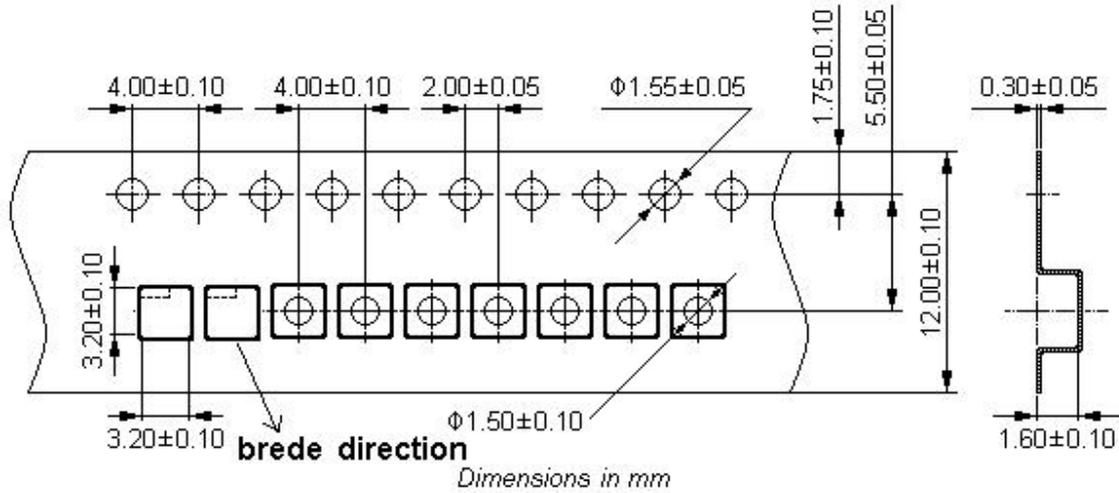


**Recommended Land Pattern**

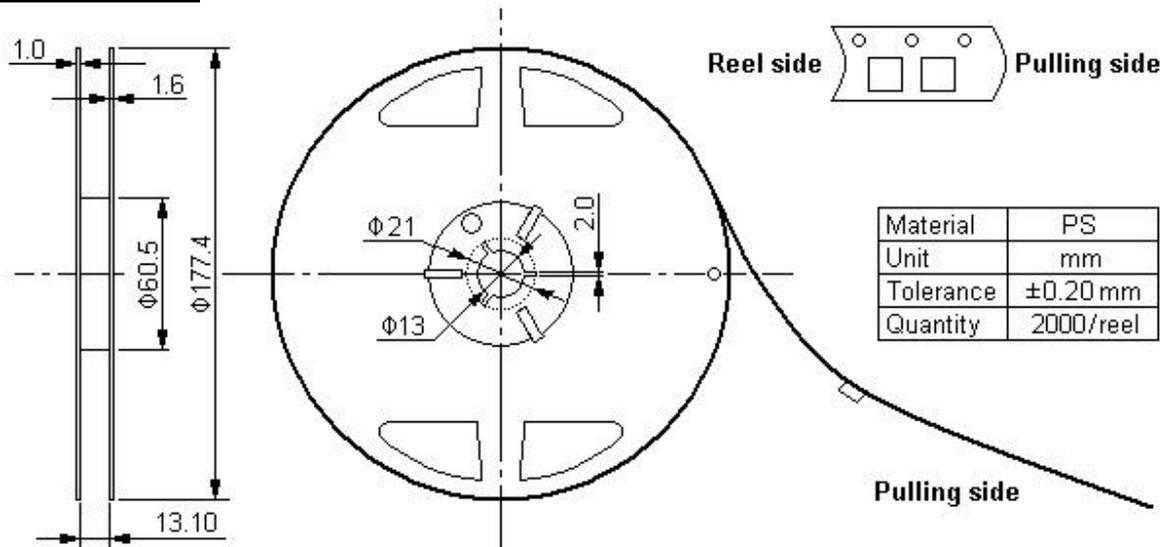


**Packing Information**

Carrier Tape



Reel Dimensions



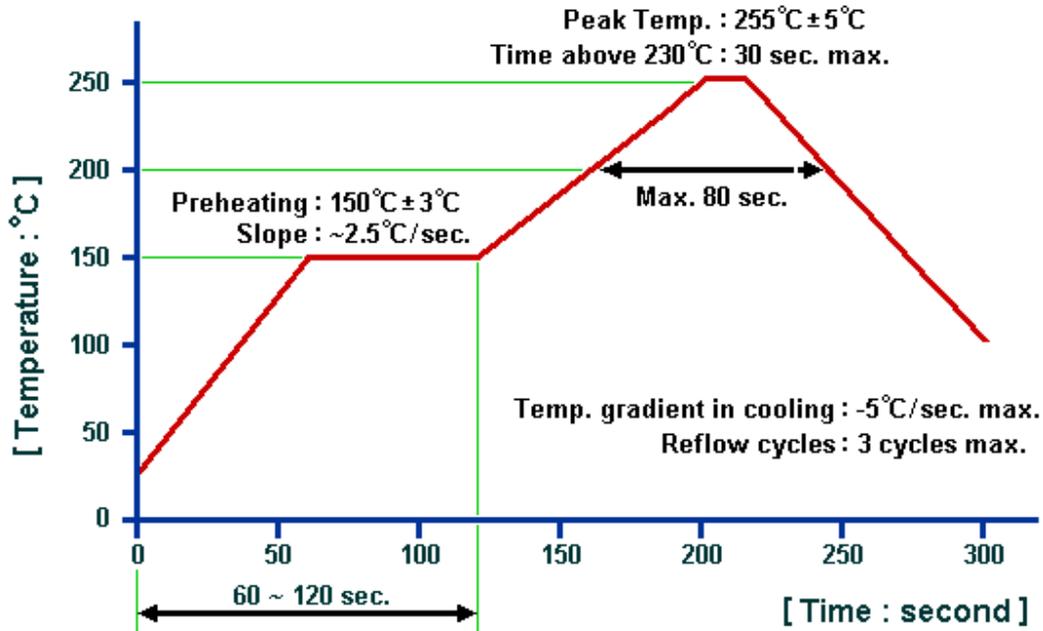
Outer Packing

Type	Quantity	Dimension	Description	Weight
Carton Box I	10000	190×190×95	anti-static plastic bag & carton box 1 reel / bag	0.85
Carton Box II	20000	190×190×190	5 bags / box (10000 pcs) 10 bags / box (20000 pcs)	1.80

Unit: mm

Unit: kg

**Recommended Soldering Profile**



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1. The specifications of this device are subject to change or obsolescence without notice.
2. Typically, equipment utilizing this device requires emissions testing and government approval, which is the responsibility of the equipment manufacturer.
3. Our liability is only assumed for the Surface Acoustic Wave (SAW) component(s) per se, not for applications, processes and circuits implemented within components or assemblies.
4. For questions on technology, prices and delivery, please contact our sales offices or e-mail [winnsky@winnsky.com](mailto:winnsky@winnsky.com)